Model No: M270C1B01 BAN

OC PN: SG2701B01-A

# PRODUCTION SPECIFICATION OF TFT LCD MODULE

Model No.: M270C1B01 BAN

OC PN: SG2701B01-A

CUSTOMER					
CONFIRMED BY					
APPROVED BY					

DILIANG ELECTRONICS				
PREPARED BY				
CONFIRMED BY				

Model No: M270C1B01 BAN

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Date	Rev.	Page	Old Description	New Description	Remark
2023.07.10	1.0	All	The specification was first issued		
		1			

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#### 1. GENERAL DESCRIPTION

#### 1.1 OVERVIEW

The specification is applied to 27" frame less module (M270C1B01 BAN) used CSOT SG2701B01-A opencell. This opencellSG2701B01-A is a diagonal 27"color active matrix LCD open cell with 2Channel LVDS interface. This open cell is a transmissive type display operating in the normally black mode. It supports 1920 x 1080 FHD resolution and can display up to 16.7M colors (8bit). Each pixel is divided into Red, Green and Blue sub-pixels which are arranged in vertical stripe. There is no backlight built-in.

This open cell dedicates for LCD Monitor products and provides excellent performance which includes high transmittance, ultra wide viewing angle and high color depth. CSOT open cell comply with RoHS for identification.

#### 1.2 General Specifications

Specification	Unit	Note
27	INCH	
630.00(H) x 368.20(V)*13.00(D)	mm	
597.888 (H) x 336.312 (V)	mm	
2650	kg	Max.
a-Si TFT Active Matrix	-	
1920 * 1080	pixel	
0.10384*0.3114	mm	
RGB Vertical Stripe	-	
16.7 M	color	6Bit+FRC
Transmissive Mode, Normally Black		
250	Cd/m²	
4000:1(Typ.)		
+89/-89 (H), +89/-89 (V) (Typ.)		
Anti-glare, Haze 2.5%, Hard Coating (3H)		
LVDS		
DE(Data Enable)		(1)
	630.00(H) x 368.20(V)*13.00(D)  597.888 (H) x 336.312 (V)  2650  a-Si TFT Active Matrix  1920 * 1080  0.10384*0.3114  RGB Vertical Stripe  16.7 M  Transmissive Mode, Normally Black  250  4000:1(Typ.)  +89/-89 (H), +89/-89 (V) (Typ.)  Anti-glare, Haze 2.5%, Hard Coating (3H)  LVDS	27 INCH 630.00(H) x 368.20(V)*13.00(D) mm 597.888 (H) x 336.312 (V) mm 2650 kg a-Si TFT Active Matrix - 1920 * 1080 pixel 0.10384*0.3114 mm RGB Vertical Stripe - 16.7 M color Transmissive Mode, Normally Black 250 Cd/m² 4000:1(Typ.) +89/-89 (H), +89/-89 (V) (Typ.) Anti-glare, Haze 2.5%, Hard Coating (3H) LVDS

#### 1.3 Mechanical Specification

	Item	Min	Тур	Max	Unit	Note
Weight		-200	2650	+200	g	-
Madula	Horizontal(H)		630.00		mm	
Module Size	Vertical (V)	(TYP)-0.5 <b>368.20</b>		(TYP)+0.5	mm	1
	Depth(D)		13.00		mm	

### 2. Absolute Maximum Ratings

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#### 2.1 Absolute Maximum Ratings

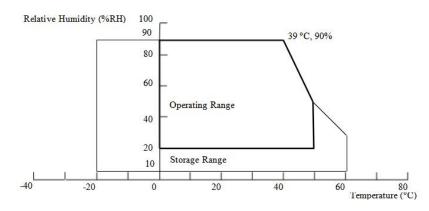
The followings are maximum values which, if exceeded, may cause damage to the unit.

Item	Symbol	Va	lue	Unit
item	Syllibol	Min.	Max.	Offic
Power Supply Voltage	VCC	-0.3	13.8	V
Input Signal Voltage	V <sub>IN</sub>	-0.3	3.6	V
Operating Temperature	Тор	0	+50	℃
Storage Temperature	Тѕт	-20	+60	°C

#### 2.2 Absolute Ratings of Environment

Item	Symbol	Min.	Max.	Unit	Conditions
Operating Temperature	TOP	0	+50	[oC]	Note 3
Glass surface temperature					
(operation)	TGS	0	+65	[oC]	Note 3, Note 4
Operation Humidity	НОР	5	90	[%RH]	
Storage Temperature	TST	-20	+60	[oC]	
Storage Humidity	HST	5	90	[%RH]	Note 3

Note 1: (1) Temperature and relative humidity range are shown as below



- (a) 90%RH maximum (TA < 39 °C).
- (b) Wet-bulb temperature should be 39  $^{\circ}$ C maximum (TA > 39  $^{\circ}$ C).
- (c) No condensation
- (2) The storage temperature is between 20 °C to 60 °C, and the operating ambient temperature is between 0 °C to 50 °C.

The maximum operating temperature is based on the test condition that the surface temperature of display area is less than or equal to 65 °C with LCD module in a temperature controlled chamber alone. Thermal management should be considered in final product design to prevent the surface temperature of display area from being over 65 °C. The range of operating temperature may degrade in case of improper thermal management in the end product design.

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(3) The rating of environment is based on LCD module. Leave LCD cell alone, this environment condition can't be guaranteed. Except LCD cell, the customer has to consider the ability of other parts of LCD module and LCD module process.

#### 2.3 Backlight Unit

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
LED operation Voltage	$V_{led}$	50.4	-	59.4	$V_{led}$	
LED operation Current	I <sub>led</sub>	-	360	-	mA	- (1)
BackLight Power	P <sub>BL</sub>	18.14	-	21.38	W	
Lift time	Lt	30000	40000	-	Hrs	

Note (1) Permanent damage to the device may occur if maximum values are exceeded. Function operation should be restricted to the conditions described under Normal operating Conditions.

#### 2.4 Package Storage

When storing module as spares for a long time, please follow the precaution instructions:

- (1) Do not store the open cell in high temperature and high humidity for a long time. It is highly recommended to store the module with temperature from 20°C to 30°C in normal humidity (50 ± 10%RH) with shipping package.
- (2) The module should be keep within six-month shelf life.

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#### 3. ELECTRICAL SPECIFICATIONS

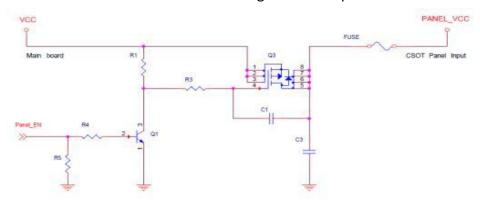
3.1 Open Cell Power Consumption (TA =  $25 \pm 2$  °C)

				,	Value			
	Parameter	Symbol	Min.	Тур.	Max.	Unit	No	ote
	Power Supply Voltage	Vcc	10.8	12.0	13.2	Vdc		-
Permiss	sive Input Ripple Voltage	VRIPPLE	-	-	400	mVp-p		(1)
	Rush Current	I <sub>RUSH</sub>	-	-	3	А	(	(2)
	White Pattern		-	290	348	А		
	Horizontal Stripe		-	380	456	А		
	Black Pattern			230	276	Α	60Hz	
	Mosaic Pattern(8*8)		1	260	312	Α		
Power Supply	White Pattern	Icc	1	270	324	Α		
Current	Horizontal Stripe		-	330	396	Α		
	Black Pattern		1	220	264	Α	100Hz	
	Mosaic Pattern(8*8)		-	240	288	А		(3)
Power			-	4.55	5.46	Watt	60Hz	
Consumption	Horizontal Stripe	Pcc	-	4.03	4.836	Watt	100Hz	

#### Note:

1)Ripple Voltage shoule be measured under the condition of VCC =12.0V,TA=25 $\pm$ 2 $^{\circ}$ C,FR =Max.(Frame Rate)condition and at that time, we recommend the bandwidth configuration of oscilloscope is to be under 20MHz.Refer to page 9 for the white pattern.

2)Inrush Current measurement condition: VCC rising time = 470 μs.



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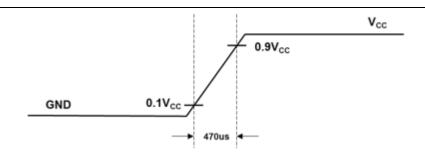


Fig. 3.1 VCC rising time condition

(3)Measurement condition: VCC = 12V(typ), Ta = 25  $\pm$  2  $^{\circ}$ C, the test patterns are shown as below. a.

a. White Pattern

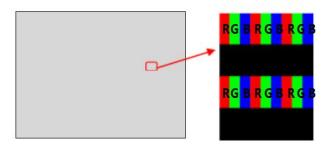
b. Black Pattern



C. Horizontal Stripe Pattern



Mosaic Pattern(8\*8)



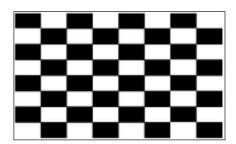


Fig. 3.2 Test patterns

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#### 3.2 LVDS Characteristics

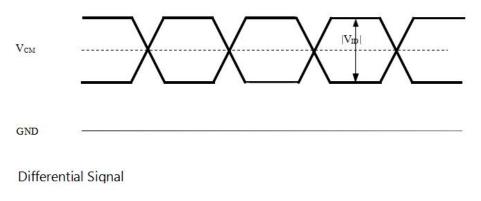
			Value				
	Parameter		Min.	Тур.	Max.	Unit	Note
	Differential Input High Threshold Voltage	V <sub>TH</sub>	+100	-	-	mV	
LVDS	Differential Input Low Threshold Voltage	V <sub>TL</sub>	_	-	-100	mV	
Interface	Common Input Voltage	V <sub>СМ</sub>	1.0	1.2	1.4	V	(1) (2)
	Differential Input Voltage		100	-	600	mV	
	Terminating Resistor	R <sub>T</sub>	87.5	100	112.5	ohm	
CMOS	Input High Threshold Voltage	V <sub>IH</sub>	2.7	-	3.3	V	
Interface	Input Low Threshold Voltage	V <sub>IL</sub>	0	-	0.7	V	

#### Note:

(1) Condition: Vcm=1.2 V

(2) The product should be always operated within above ranges.

(3) The LVDS input signal has been defined as follows:



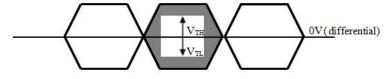


Fig. 3.3 LVDS input signal

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### 3.3 Temperature Specifications

Daramotor	Symbol	Sı	oecificatio	n	Unit	Pacammandad tast nattorn	Note
Parameter	Symbol	Min.	Тур.	Max.	Offic	Recommended test pattern	Note
Surface	T <sub>TCON</sub>	-	-	100	°C	Horizontal Pattern	(1)
Temperature	T <sub>PMIC</sub>			100		Horizontal Pattern	(1)
	T <sub>Driver</sub>	-	-	115		Horizontal Pattern	(1)

#### Note:

(1) Any point on the IC surface must be less than Max. specification, If the surface temperature is out of the specification, thermal solutions should be applied to avoid be damaged. The IC surface temperature is measured at room temperature of  $25^{\circ}$ C.

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### 3.4. Input Terminal Pin Assignment

### 3.4.1 CN1: 187114-30091 (P2) or equivalent (see Note(1))

	Symbol	Function			
1	RX1 AN	Negative LVDS differential data output			
2	RX1 AP	Positive LVDS differential data output			
3	RX1BN	Negative LVDS differential data output			
4	RX1 BP	Positive LVDS differential data output			
5	RX1 CN	Negative LVDS differential data output			
6	RX1 CP	Positive LVDS differential data output			
7	GND	Ground			
8	RX1CLKN	Negative Sampling Clock			
9	RX1CLKP	Positive Sampling Clock			
10	RX1 DN	Negative LVDS differential data output			
11	RX1 DP	Positive LVDS differential data output			
12	RX2 AN	Negative LVDS differential data output			
13	RX2 AP	Positive LVDS differential data output			
14	GND	Ground			
15	RX2BN	Negative LVDS differential data output			
16	RX2 BP	Positive LVDS differential data output			
17	GND	Ground			
18	RX2 CN	Negative LVDS differential data output			
19	RX2 CP	Positive LVDS differential data output			
20	RX2CLKN	Negative Sampling Clock			
21	RX2CLKP	Positive Sampling Clock			
22	RX2 DN	Negative LVDS differential data output			
23	RX2 DP	Positive LVDS differential data output			
24	GND	Ground			

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25	SDA_I	* Reserved for LCD manufacturer's use (SDA)
26	SCL_I	* Reserved for LCD manufacturer's use (SCL)
27	B_INT	* Reserved for LCD manufacturer's use (WPN)
28	PVDD	
29	PVDD	Input Power Supply: +12V
30	PVDD	

Note(1): The direction of pin assignment is shown as below:

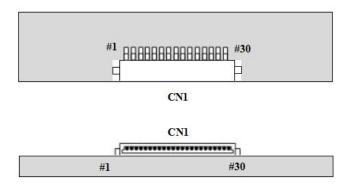


Fig. 4.1 Connector direction sketch map

### 3.4.2 Block Diagram of Interface

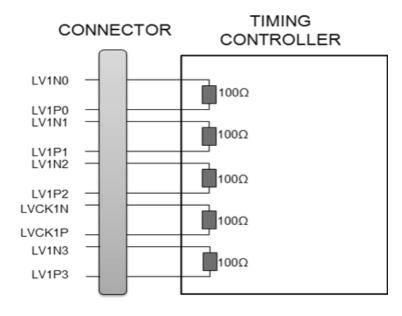


Fig. 4.2 Block diagram of interface

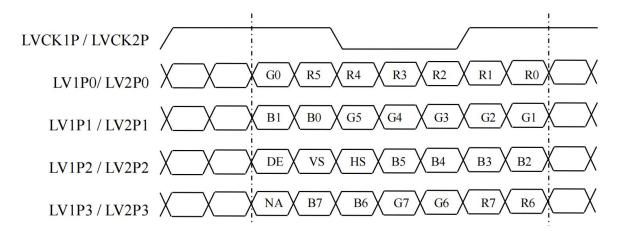
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#### Attention:

- (1) This open cell uses a 100 ohms  $(\Omega)$  resistor between positive and negative lines of each receiver input.
- (2) LVDS cable impedance shall be 50 ohms per signal line or about 100 ohms per twist-pair line respectively

### 3.4.3 LVDS Interface



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### 3.5 Backlight Electrical / Optical Characteristics

3.5.1 backlight connector

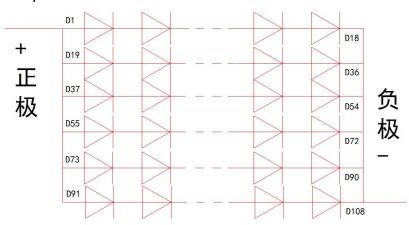
"CN2: PH2.0-2P

Pin#	Signal Name				
1	VDD-				
2	VDD+				

#### 3.5.2 LED Bar

Parameter	Symbols	Min	Тур	Max	Unit
Forward Voltage (one circuit)	VF	2.8	-	3.6	MHz
Reverse Current (one circuit)	IR	-	-	10	μΑ
Forward Current	IF	-	90	120	Ma
Chromaticity Coordinates	X	0.2385	0.2585	0.2785	
Chromaticity Coordinates	Y	0.2052	0.2252	0.2452	
Lumen	¢	34	36	38	LM
Viewing Angle	201/2	-	120	-	Deg.
Number Of LED	Pcs	-	108	-	Pcs
Operation Voltage(LB)	VLB	50.4	-	59.4	V
Operation Current(LB)	ILB	-	360	-	mA
Power Consumption	PLB	18.1	-	21.3	W

### Array Mode Of LED Bar



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### 3.6 Timing spec

Item		Symbol	Min.	Тур.	Max.	Unit	Note
Frequency		Dclk	60	74.25	95.15	MHz	(1)
F	rame Rate	F <sub>R</sub>	48	60	75	Hz	
Vertical Term	Total	Tv	1100	1125	1802	Line	$T_{V} = T_{VD} + T_{VB}$ (2)
	Active Display	T <sub>VD</sub>	1080		Line		
	Blank	T <sub>VB</sub>	20	45	722	Line	
Horizontal	Total	T <sub>H</sub>	1046	1100	1174	Pixel	TH = THD + THB
Term	Active Display	T <sub>HD</sub>	960		Pixel		
	Blank	T <sub>HB</sub>	86	140	214	Pixel	
	Input cycle to cycle jitter	Trcl	_	_	200	ps	(3)
LVDS Receiver	Spread spectrum modulation range	Fclkin_m od	Fclkin- 2%	_	Fclkin+2 %	MHz	
Clock	Spread spectrum	FSSM	10		200	KHz	(4)
LVDS Receiver Data	Receiver Skew Margin	TRSM	-380	_	380	ps	(5)

#### Note:

- (1) The TFT LCD open cell is operated in DE only mode, H sync and V sync input signal have no effect on normal operation.
- (2) Dclk =  $TH \times TV \times FR$ , TH, TV and FR should operate within the range between Pixel clock frequency Min. and Pixel clock frequency Max..

#### Attention:

The module is operated in DE only mode, H sync and V sync input signal have no effect on normal operation.

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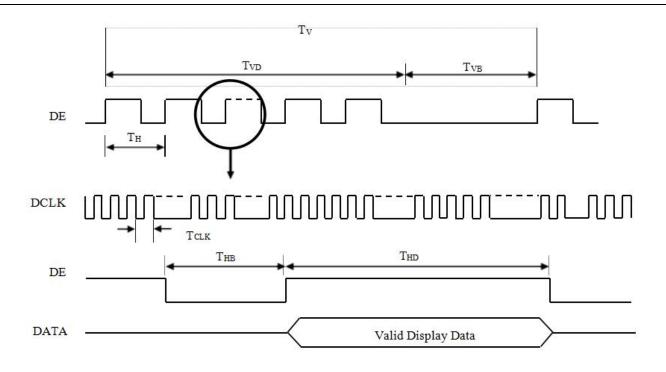


Fig. 3.6.1 Interface signal timing diagram

(3) The input clock cycle-to-cycle is defined as below figures.

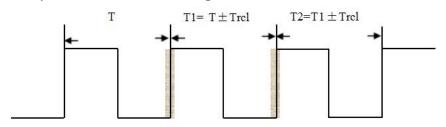


Fig. 3.6.2 Jitter

(4) The SSM (Spread Spectrum Modulation) is defined as the following figure. The LVDS SSM's suggestion is disabled by default; SOC board should test all validation if SOC board enables the LVDS SSM.

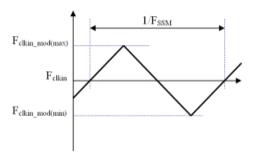


Fig. 3.6.3 SSM

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(5) The LVDS timing diagram and setup/hold time is defined in the following figure.

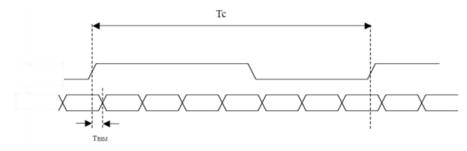


Fig.3.6.4 LVDS receiver interface timing diagram

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#### 3.7 Power On/Off Sequence

The power sequence specifications are shown as the following diagram and table.

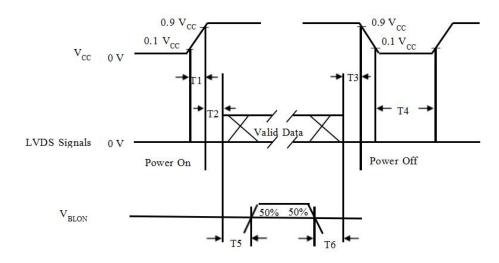


Fig. 3.7.1 Power on/off signal sequence

Parameter		Unit			
rarameter	Min.	Тур.	Max.	Offic	
T1	0.5	-	10	ms	
T2	20	-	-	ms	
Т3	100	-	-	ms	
T4	1000	_	-	ms	
T5	500	_	-	ms	
T6	100	_	-	ms	

#### Attention:

- (1) The supplied voltage of the external system for the open cell input should follow the definition of VCC.
- (2) When the backlight turns on before the LCD operation or the LCD turns off before the backlight turns off, the display may momentarily become abnormal screen.
- (3) In case that VCC is in off level, keep the level of input signals on the low or high impedance. If T2 < 0, that may cause electrical overstress.
- (4) T4 should be measured after the module has been fully discharged between power off and on period.
- (5) Interface signal shall not be kept at high impedance when the power is on.

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### **4 Optical Characteristics**

#### **4.1 Test Condition**

Item	Symbol	Value	Unit		
Ambient Temperature	Та	25 ± 2	$^{\circ}$		
Ambient Humidity	На	50 ± 10	%RH		
Supply Voltage	Vcc	5.0	V		
	According to typical value in "3. ELECTRICAL				
Input Signal	nput Signal CHARACTERISTICS"				
LED Input Voltage	$V_{LED}$	52	V		
LED Input Current	I <sub>LED</sub>	360	mA		
Power Consumption	Pw	18.7	W		

### **4.2 Optical Characteristics**

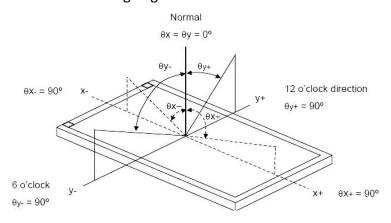
The relative measurement methods of optical characteristics are shown as below. The following items should be measured under the test conditions described in 4.1

Ite	m	Symbol	Condition	Min.	Тур.	Max.	Unit	Note		
Contrast Ratio		CR		3000	4000	_	_	_		
Response Ti	me(OD ON)	TL	FR=75Hz	_	-   6.5   12	12	ms	Note 2		
Response Tir	me(OD OFF)	TL	FR=75Hz	_	14	20	ms	Note 3		
Brightness	uniformity	BU		70	75	_	_	Note 2		
Center Lumina	ance of White	Lc		220	250	_	cd/m2	_		
	Dod	Rx	0000	Тур.	0.650	Typ. +0.03	_	_		
	Red	Ry	θx=0,θy=0		0.335		_	_		
	Green	Gx	, , , , , , , , , , , , , , , , , , ,		0.301		_	_		
The color	Gleen	Gy	viewing normal angle		0.612		_	_		
chromatic	Blue	Bx		-0.03	0.150		_	_		
	blue	Ву		angle		0.059		_	_	
	White	Wx							0.313	
	vvriite	Wy			0.329		_	_		
	Horizontal	θх+	- CR≧10	_	89	_	Dan			
Viewing		θх-		_	89	_		Note 1		
Angle	\	θу+		_	89	_	Deg	Note 1		
	Vertical	θу-		_	89	_				

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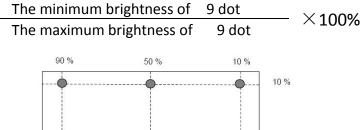
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Note 1: The definition of viewing angle



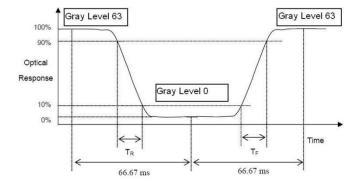
Note 2: Definition of luminance, CR measured positions and brightness uniformity

- (a) Measure White luminance on the below 9 points and take the average value.
- (b) CR : measures the same 9 points and take the average value .The Definition of Contrast Ratio is as follows :
- CR = ON(white L63)Luminance / OFF (Black L0)Luminance
- (c) The definition of White Vibration



50 %

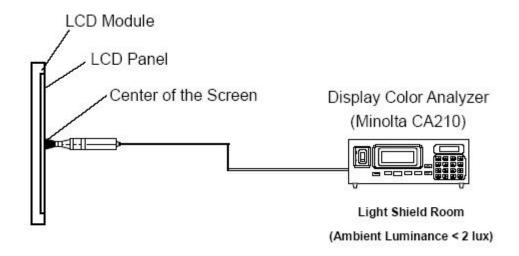
Note 3:Definition of Response Time (TR, TF):



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Note 4: The measure method



(a) : The measurement point is the center of the active area except for the measurement of Luminance Uniformity

(b): Photometer: CA-210

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### 5.0 Reliability Test

Environment test conditions are listed as following table.

Items	Required Condition	Note
Temperature Humidity Bias (THB)	Ta= 50℃,80%RH, 300hours	
High Temperature Operation (HTO)	Ta= 50°C , 50%RH, 300hours	
Low Temperature Operation (LTO)	Ta= $0^{\circ}$ C, 300hours	
High Temperature Storage (HTS)	Ta= $60^{\circ}$ C, 300hours	
Low Temperature Storage (LTS)	Ta= -20°C , 300hours	
Vibration Test (Non-operation)	Acceleration: 1.5 Grms Wave: Random Frequency: 10 - 200 Hz Sweep: 30 Minutes each Axis (X, Y, Z)	
Shock Test (Non-operation)	Acceleration: 50 G Wave: Half-sine Active Time: 20 ms Direction:±X,±Y,±Z(one time for each Axis)	
Drop Test	Height: 60 cm, package test	
Thermal Shock Test (TST)	-20°C/30min, 60°C/30min, 100 cycles	1
On/Off Test	On/10sec, Off/10sec, 30,000 cycles	
	Contact Discharge: ± 8KV, 150pF(330 ) 1sec, 8 points, 25 times/ point.	
ESD (Electro Static Discharge)	Air Discharge: ± 15KV, 150pF(330 ) 1sec 8 points, 25 times/ point.	2

Note 1: The TFT-LCD module will not sustain damage after being subjected to 100 cycles of rapid temperature change. A cycle of rapid temperature change consists of varying the temperature from  $-20^{\circ}$ C to  $60^{\circ}$ C, and back again. Power is not applied during the test. After temperature cycling, the unit is placed in normal room ambient for at least 4 hours before power on.

Note 2: EN61000-4-2, ESD class B: Certain performance degradation allowed

No data lost

Self-recoverable

No hardware failures.

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### 6.0 Shipping Label

#### 6.1Panel Label

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OC PN : SG2701B01-A

**ABCDEFGHIJKLMNHIJK** 

**RoHS** 

#### 6.2 Carton Label

**ABCDEFGHIJKLMN** 

Model No:(型号): M270C1B01 BAN

OC PN : SG2701B01-A

QTY(数量) : **b** PCS/CTN

N.W(净重) : KG

G.W(毛重) : KG

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### 7. Packaging

### 7.1 Carton(internal package)

- (1)Packaging Form
- (2) Packaging Method

Note 1) Acceptable number of piling: 8 sets

### 7.2 Packing Mark











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#### 8. PRECAUTION

#### **8.1 ASSEMBLY AND HANDLING PRECAUTIONS**

- 1 Do not apply rough force such as bending or twisting to the module during assembly.
- 2 To assemble or install module into user's system can be in clean working areas. The dust and oil may cause electrical short or worsen the polarizer.
- 3 It's not permitted to have pressure or impulse on the module because the LED panel and Backlight will be damaged.
- 4 Always follow the correct power sequence when LED module is connecting and operating. This can prevent damage to the CMOS LSI chips during latch-up.
- 5 Do not pull the I/F connector in or out while the module is operating.
- Do not disassemble the module.
   Use a soft dry cloth without chemicals for cleaning, because the surface of polarizer is very
- 7 soft and easily scratched.
- 8 It is dangerous that moisture come into or contacted the LED module, because moisture may damage LED module when it is operating.
- 9 High temperature or humidity may reduce the performance of module. Please store LED module within the specified storage conditions.
- 10 When ambient temperature is lower than 10 °C may reduce the display quality. For example, the response time will become slowly.

#### **8.2 SAFETY PRECAUTIONS**

- 1 It is dangerous that moisture come into or contacted the LED module, because the moisture may damage LED module when it is operating.
- If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth, in case of contact with hands, skin or clothes, it has to be washed away thoroughly with soap.
- 3 After the modlule's end of life, it is not harmful in case of normal operation and storage.

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### 9. Outline dimensions

